

## 15-Ampere N-P-N Power Transistors

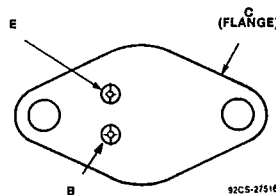
High-Voltage N-P-N Types for Off-Line Power Supplies  
and Other High-Voltage Switching Applications

### Features:

- 100° C maximum limits specified for:
  - Switching times
  - Saturation voltages
  - Leakage currents
- Very fast turn-off,  $t_f < 100$  nsec (typ.)  
@ 15A - inductive load

The D64VS series of silicon n-p-n power transistors are designed for use in power switching applications requiring high-voltage capability, fast switching speeds, and low-saturation voltages. These devices are optimized to provide a unique combination of ultra-low switching losses and high safe-operating-area (SOA). They are ideally suited for off-line switching power supplies, inverter/converter circuits, and pulse width modulated regulators.

### TERMINAL DESIGNATIONS



JEDEC TO -204AA

### MAXIMUM RATINGS ( $T_A = 25^\circ \text{C}$ ) (unless otherwise specified)

RATING	SYMBOL	D64VS3	D64VS4	D64VS5	UNITS
Collector-Emitter Voltage	$V_{CEO}$	300	350	400	Volts
Collector-Emitter Voltage	$V_{CEX}$	300	350	400	Volts
Collector-Emitter Voltage	$V_{CEV}$	450	500	550	Volts
Emitter Base Voltage	$V_{EBO}$	7	7	7	Volts
Collector Current — Continuous	$I_C$	15	15	15	A
Peak <sup>(1)</sup>	$I_{CM}$	30	30	30	
Base Current — Continuous	$I_B$	5	5	5	A
Peak <sup>(1)</sup>	$I_{BM}$	10	10	10	
Emitter Current — Continuous	$I_E$	20	20	20	A
Peak <sup>(1)</sup>	$I_{EM}$	35	35	35	
Total Power Dissipation @ $T_c = 25^\circ \text{C}$	$P_D$	195	195	195	Watts
@ $T_c = 100^\circ \text{C}$		111	111	111	
Derate above $25^\circ \text{C}$		1.11	1.11	1.11	W/°C
Operating and Storage Junction Temperature Range	$T_J, T_{STG}$	-65 to +200	-65 to +200	-65 to +200	°C

### THERMAL CHARACTERISTICS

Parameter	Symbol	D64VS3	D64VS4	D64VS5	Units
Thermal Resistance, Junction to Case	$R_{\theta JC}$	0.9	0.9	0.9	°C/W
Maximum Lead Temperature for Soldering Purpose: 1/8" from Case for 5 Seconds	$T_L$	235	235	235	°C

(1) Pulse condition,  $t_p \leq 5$  msec.

ELECTRICAL CHARACTERISTICS ( $T_C = 25^\circ\text{C}$ ) (unless otherwise specified)

CHARACTERISTIC	SYMBOL	MIN	MAX	UNIT	
<b>OFF CHARACTERISTICS<sup>(1)</sup></b>					
Collector-Emitter Sustaining Voltage <sup>(1)</sup> ( $I_C = 100\text{mA}$ )	D64VS3 D64VS4 D64VS5	$V_{CEO(sus)}$	300 350 400	— — —	Volts
Collector-Emitter Voltage ( $I_C = 15\text{A}$ , $I_{B1} = 2.5\text{A}$ , $I_{B2} = -3.0\text{A}$ ) ( $V_{BE(OFF)} = -6\text{V}$ , $L = 200\ \mu\text{h}$ )	D64VS3 D64VS4 D64VS5	$V_{CEX}$	300 350 400	— — —	Volts
Collector Cutoff Current ( $V_{CEV} = \text{Rated Value}$ , $V_{BE(OFF)} = -1.5\text{V}$ ) ( $V_{CEV} = \text{Rated Value}$ , $V_{BE(OFF)} = -1.5\text{V}$ , $T_C = 100^\circ\text{C}$ )		$I_{CEV}$	— —	0.1 1.0	mA
Emitter Cutoff Current ( $V_{EB} = 7\text{V}$ )		$I_{EBO}$	—	1.0	mA

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## SECOND BREAKDOWN

Second Breakdown with Base Forward Biased	FBSOA	SEE FIGURE 13
Clamped Inductive SOA with Base Reversed Bias	RBSOA	SEE FIGURE 14

ON CHARACTERISTICS<sup>(1)</sup>

DC Current Gain ( $I_C = 10\text{A}$ , $V_{CE} = 2\text{V}$ ) ( $I_C = 15\text{A}$ , $V_{CE} = 2\text{V}$ )	$h_{FE}$	10 8	— —	—
Collector-Emitter Saturation Voltage ( $I_C = 10\text{A}$ , $I_B = 1.67\text{A}$ ) ( $I_C = 15\text{A}$ , $I_B = 2.5\text{A}$ ) ( $I_C = 15\text{A}$ , $I_B = 2.5\text{A}$ , $T_C = 100^\circ\text{C}$ )	$V_{CE(SAT)}$	— — —	0.7 1.0 1.5	Volts
Base-Emitter Saturation Voltage ( $I_C = 15\text{A}$ , $I_B = 2.5\text{A}$ ) ( $I_C = 15\text{A}$ , $I_B = 2.5\text{A}$ , $T_C = 100^\circ\text{C}$ )	$V_{BE(SAT)}$	— —	1.5 1.5	Volts

## DYNAMIC CHARACTERISTICS

Current Gain — Bandwidth Product ( $I_C = 1.0\text{A}$ , $V_{CE} = 10\text{V}$ , $f_{test} = 1.0\text{MHz}$ )	$f_T$	15	50	MHz
Output Capacitance ( $V_{CB} = 10\text{V}$ , $I_E = 0$ , $f = 0.1\text{MHz}$ )	$C_{OB}$	150	360	pF

## SWITCHING CHARACTERISTICS

		MAXIMUM			
Resistive Load (See Figure 17 for Test Circuit)		$T_C$	$25^\circ\text{C}$	$100^\circ\text{C}$	
Delay Time	$V_{CC} = 250\text{V}$ , $I_C = 15\text{A}$	$t_d$	0.1	0.2	$\mu\text{s}$
Rise Time	$I_{B1} = 2.5$ , $I_{B2} = -3.0\text{A}$ , $t_p = 50\ \mu\text{sec}$	$t_r$	0.5	0.7	$\mu\text{sec}$
Storage Time		$t_s$	2.5	3.0	$\mu\text{sec}$
Fall Time		$t_f$	0.4	0.7	$\mu\text{sec}$
Inductive Load, Clamped (See Figure 17 for Test Circuit)					
Storage Time	$I_C = 15\text{A}$ , $V_{CLAMP} = 250\text{V}$ $I_{B1} = 2.5\text{A}$ , $I_{B2} = -3.0\text{A}$ , $V_{BE(OFF)} = -6\text{V}$ $L = 200\ \mu\text{h}$ , $t_p = 25\ \mu\text{sec}$	$t_s$	3.0	3.5	$\mu\text{s}$
Fall Time		$t_f$	0.3	0.6	$\mu\text{sec}$
		TYPICAL			
Storage Time		$t_s$	1.8	2.5	$\mu\text{sec}$
Fall Time		$t_f$	0.085	0.13	$\mu\text{sec}$

(1) Pulse Duration = 300 $\mu\text{s}$ , Duty Factor  $\leq 2\%$ . Do not measure on a curve tracer.

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TYPICAL DC CHARACTERISTICS

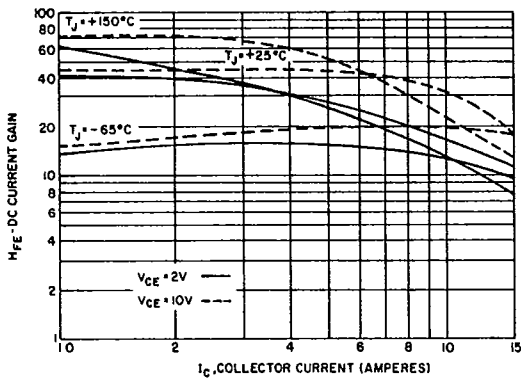


FIGURE 1. DC CURRENT GAIN

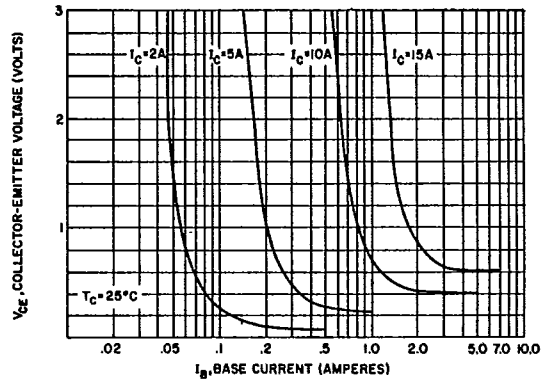


FIGURE 2. COLLECTOR SATURATION REGION

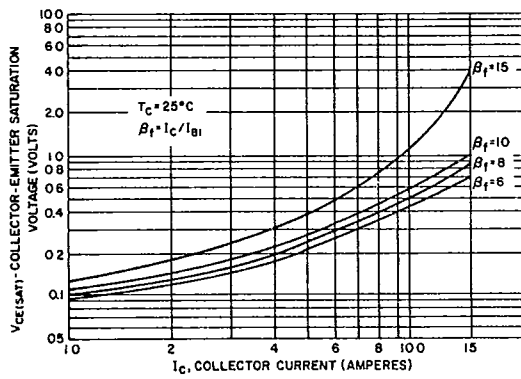


FIGURE 3. VCE(sat) vs IC, TC = 25°C

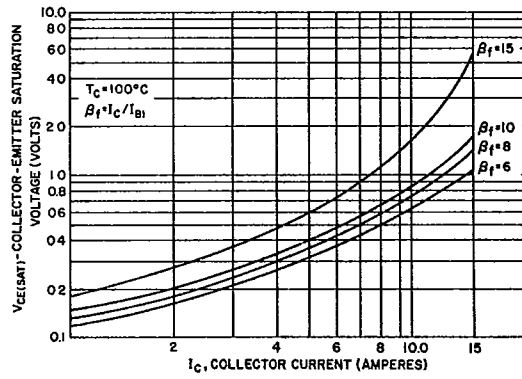


FIGURE 4. VCE(sat) vs IC, TC = 100°C

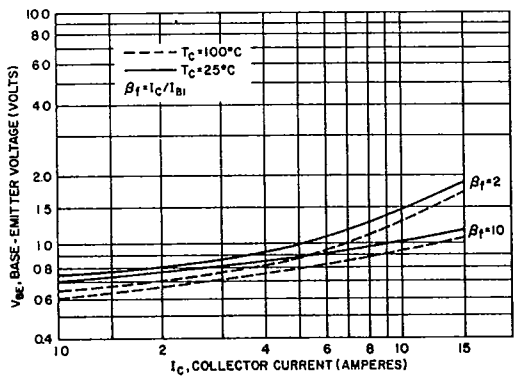


FIGURE 5. VBE(sat) vs IC

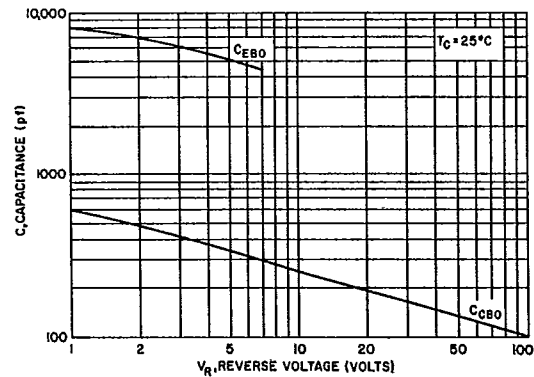


FIGURE 6. CAPACITANCE

HARRIS SEMICONDUCTOR SECTOR 27E D 430227J 0020378 0 HAS

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HARRIS SEMICOND SECTOR

27E D

4302271 0020379 2 HAS

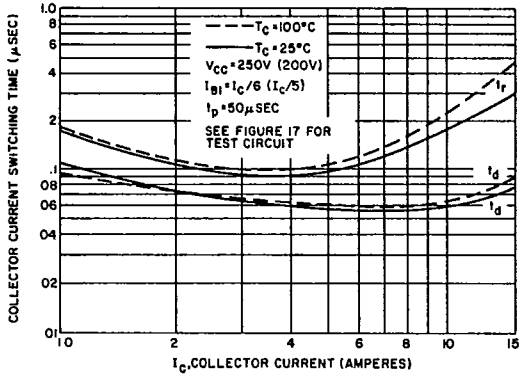


FIGURE 7. TURN-ON TIME RESISTIVE LOAD

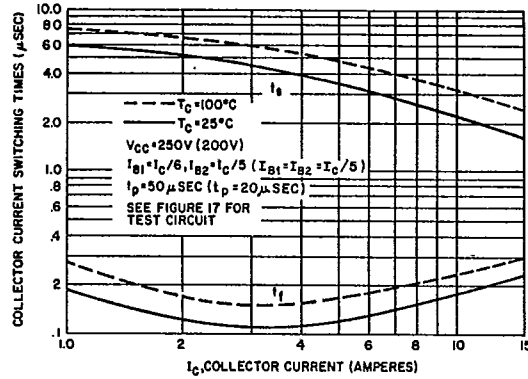


FIGURE 8. TURN-OFF TIME RESISTIVE LOAD

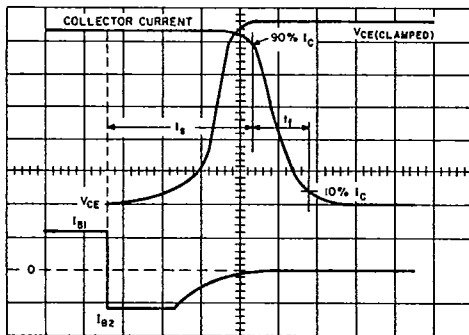


FIGURE 9. INDUCTIVE TURN-OFF WAVEFORMS

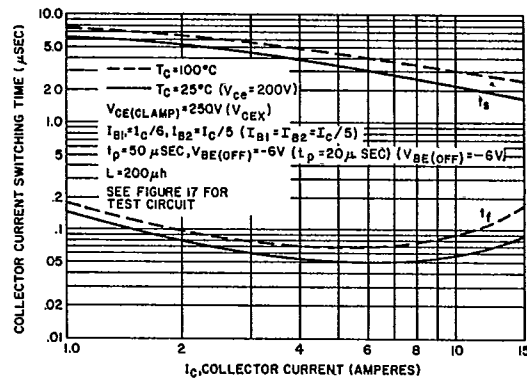


FIGURE 10. CLAMPED INDUCTIVE TURN-OFF TIME

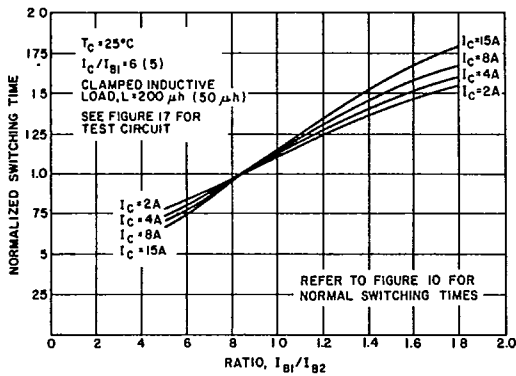


FIGURE 11. STORAGE TIME VARIATION WITH  $I_{B2}$

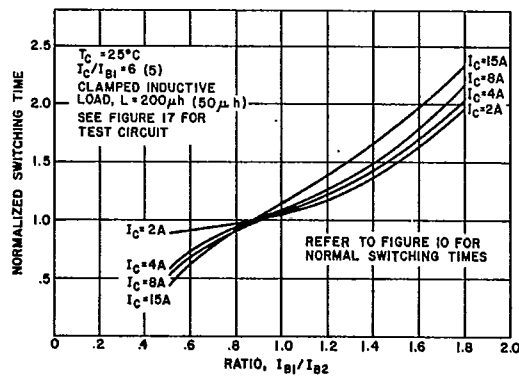


FIGURE 12. FALL TIME VARIATION WITH  $I_{B2}$

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HARRIS SEMICOND SECTOR

27E D

4302271 0020380 9 HAS

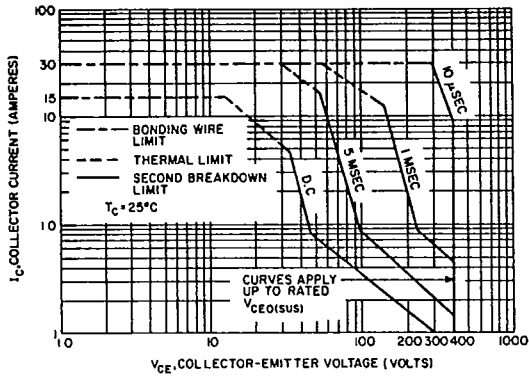


FIGURE 13. FORWARD BIAS SAFE OPERATING AREA

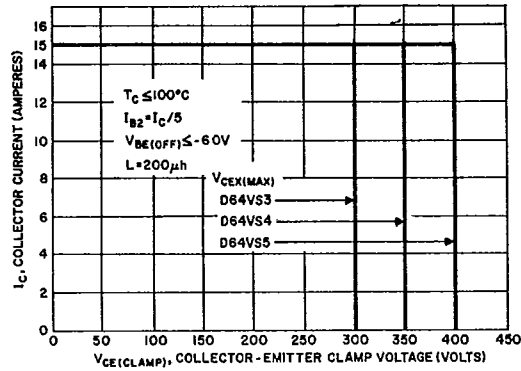


FIGURE 14. CLAMPED REVERSE BIAS SAFE OPERATING AREA

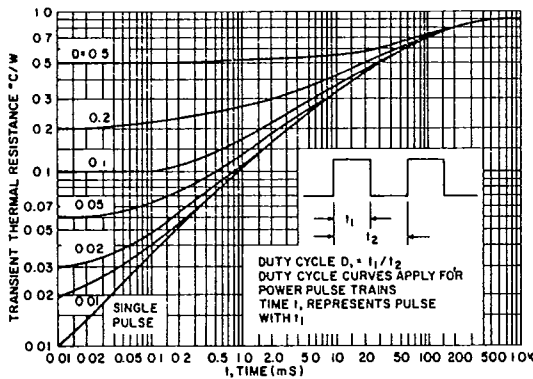


FIGURE 15. TRANSIENT THERMAL RESPONSE

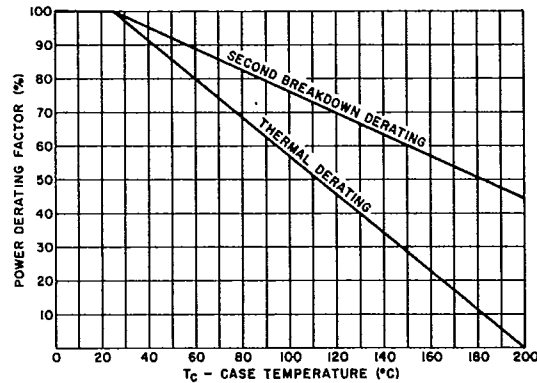


FIGURE 16. POWER DERATING

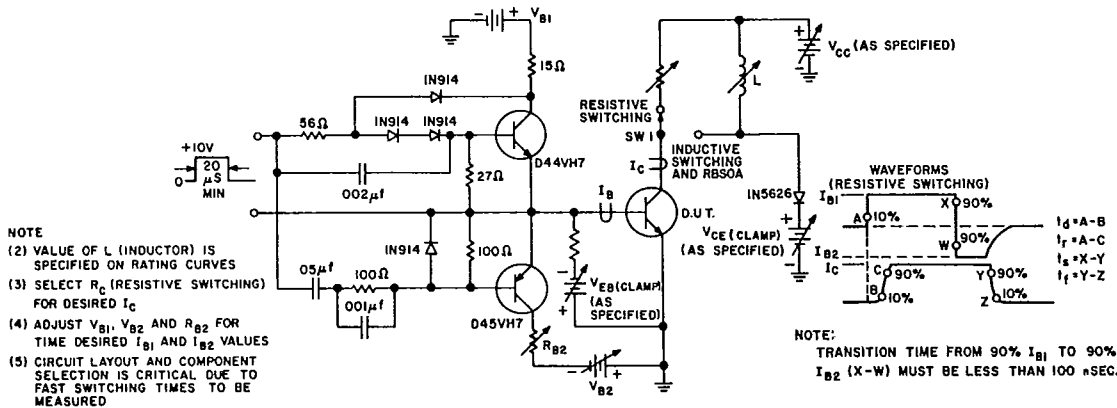


FIGURE 17. TEST CIRCUIT FOR SWITCHING TIMES AND RBSOA